

August 2006 - Rev 02-Aug-06 CMM2030-BD

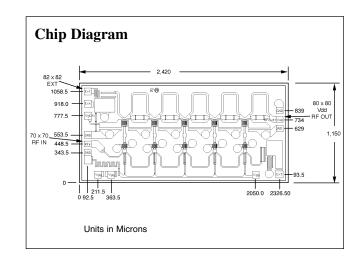
SMA2020 DD

Features

- **☐** Small Size
- ☐ High Gain: 12 dB Typical
- \square P1dB = +18 dBm, Typical
- □ 30 kHz to 30 GHz Bandwidth
- ☐ Low Gain Ripple: 1.0 dB pp Typical
- ☐ Sub 0.25 Micron PHEMT
- **□** Low DC Power Consumption

Applications

- ☐ Input Stage Driver for LiNb0₃ Modulator Driver Amplifier @ OC-192
- ☐ Medium Power Linear Gain Block for Broadband Systems
- ☐ Receive Amplifier for OC-192



Description

The CMM2030-BD is a precision GaAs MMIC, medium power amplifier and is part of Celeritek's family of WideFiberTM products for optical communications applications.

The CMM2030-BD optical driver amplifier gives fiber optic system designers a unique combination of wideband frequency coverage, along with a flat response and very low internal jitter. It is a precision PHEMT GaAs MMIC medium power amplifier with +18 dBm @ P1dB. It operates from 30 kHz to 32 GHz with 12 dB linear gain. Low internal

jitter makes it especially well suited for high speed digital data applications.

It is an excellent choice as an input stage amplifier for Lithium Niobate (Mach-Zehnder) external modulator driver amplifiers for OC-192/STM64 metropolitan and long-haul dense wave-division multiplexed optical networking applications and other high speed applications.

When used as an amplifier to drive Celeritek's CMM3030-BD as much as 7.5 V peak-to-peak can be achieved.

CMM2030-BD amplifiers are shipped in Gel Pack from Celeritek's foundry.

Parameters	Units	Min	Тур	Max
Frequency Range	_	30 kHz		30.0 GHz
Small Signal Gain	dB	10.0	12.0	
Gain Flatness	±dB		0.6	
Input VSWR	_		1.8:1	
Output VSWR	_		1.7:1	
Power Output (@1 dB Gain Compression) @ 9 GHz	dBm		+18.0	
Current	mA		100	150



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Absolute Maximum Ratings

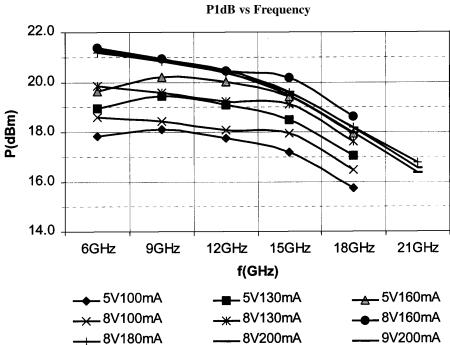
Parameter	Rating		
Drain Voltage	12 V		
Gate Voltage	-5 V		
Drain Current	375 mA		
Continuous Power Dissipation	3.0 W		
Channel Temperature	+175°C		
Storage Temperature	-65°C to +175°C		
Mounting Temperature	+320°C		
Input Power	+23 dBm		

Die Attach and Bonding Procedures

Die Attach: Eutectic die attach is recommended. For eutectic die attach: Preform: AuSn (80% Au, 20% Sn); Stage Temperature: 290°C, ±5°C; Handling Tool: Tweezers; Time: 1 min or less.

Wire Bonding: Wire Size: 0.7 to 1.0 mil in diameter (prestressed); Thermocompression bonding is preferred over thermosonic bonding. For thermocompression bonding: Stage Temperature: 250°C; Bond Tip Temperature: 150°C; Bonding Tip Pressure: 18 to 40 gms depending on size of wire.

Typical Performance



Performance Optimization

Using the Gain-Ctl facility of the CMM2030-BD, output power may be increased by application of 1.2 to 1.8 Volts to the Bias Control pad. If the Gain-Ctl facility is not used, a fixed voltage at the Bias Control pad can be implemented by

connecting a off-chip parallel resistor to the pad which will lower the output voltage accordingly.

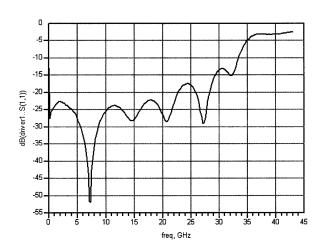
If Bias Control voltage is decreased further than those lowest values given in the tables, both gain and output power will start to drop.



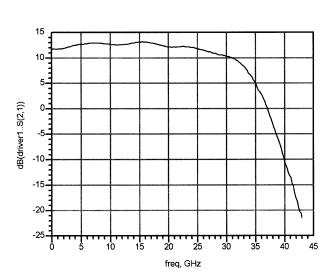
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Typical Performance

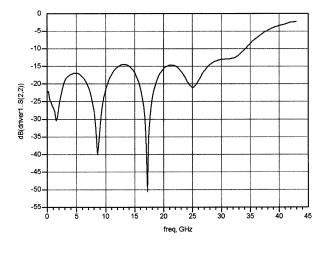
S11 vs Frequency



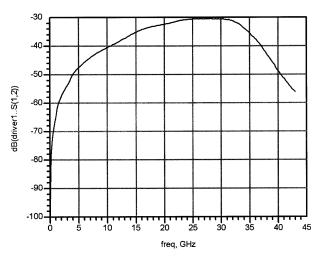
S21 vs Frequency



S22 vs Frequency



S12 vs Frequency

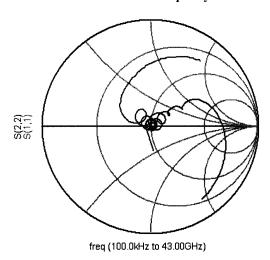




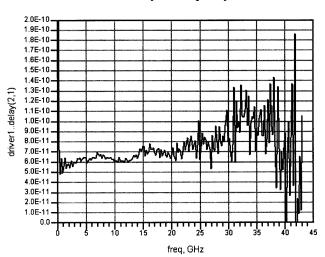
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Typical Performance

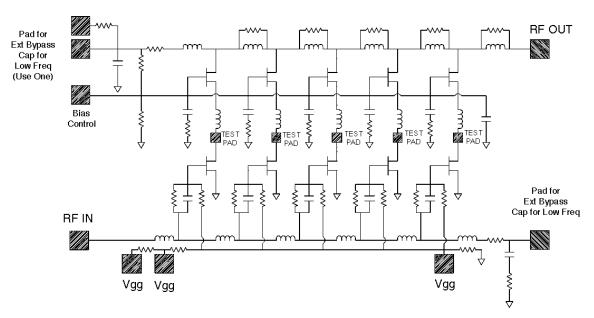
S22 & S11 vs Frequency



Gain Delay vs Frequency



Schematic Diagram



Ordering Information

Part Number for Ordering CMM2030-BD

Description

Optical Modulator Driver Amplifier